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BGU7045 1 GHz wideband low-noise amplifier with bypass Rev. 3 – 11 April 2018 Pro

Product data sheet

Product profile 1

1.1 General description

The BGU7045 MMIC is a 3.3 V wideband amplifier with bypass mode. It is designed specifically for high linearity, low-noise applications over a frequency range of 40 MHz to 1 GHz. It is especially suited for Set-Top Box applications.

The LNA is housed in a 6-pin SOT363 plastic SMD package.

1.2 Features and benefits

- Voltage supply of 3.3 V
- · Internally biased
- Programmable between G_p = 14 dB and bypass
- Flat gain between 40 MHz and 1 GHz
- Noise figure of 2.8 dB
- High linearity with an $\mbox{IP3}_{O}$ of 29 dBm
- 75 Ω input and output impedance
- · Power-down during bypass mode
- Bypass mode current consumption < 5 mA
- ESD protection > 2 kV Human Body Model (HBM) and >1.5 kV Charged Device Model (CDM) on all pins

1.3 Applications

- Terrestrial and cable Set-Top Boxes (STB)
- Silicon and "Can" tuners
- Personal Video Recorders (PVR) and Digital Video Recorders (DVR)
- · Home networking and in-house signal distribution



1.4 Quick reference data

Table 1. Quick reference data

 T_{amb} = 25 °C; typical values at V_{CC} = 3.3 V; Z_S = Z_L = 75 Ω ; R_{bias} = 18 Ω ; 40 MHz ≤ f_1 ≤ 1000 MHz.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{CC}	supply voltage	RF input AC coupled		3.1	3.3	3.5	V
I _{CC(tot)}	total supply current	G _p = 14 dB mode	[1]	30	34	38	mA
		bypass mode	[1]	-	3	-	mA
T _{amb}	ambient temperature			-40	-	+85	°C
NF	noise figure	G _p = 14 dB mode	[1]	-	2.8	-	dB
		bypass mode	[1]	-	2.5	-	dB
P _{L(1dB)}	output power at 1 dB gain compression	G _p = 14 dB mode; 1 GHz	[1]	-	13	-	dBm
IP3 ₀	output third-order intercept point	G _p = 14 dB mode	[1][2]	-	29	-	dBm

[1] [2]

Mode depends on setting of V_{CTRL} ; see <u>Table 8</u>. The fundamental frequency (f₁) is 1000 MHz. The intermodulation product (IM3) is 2 x f₂ - f₁, where f₂ = f₁ ± 1 MHz. Input power P_i = -10 dBm.

Pinning information 2

Table 2. Pinning							
Pin	Description	Simplified outline Graphic syn	nbol				
1	RF_OUT						
2	V _{CC}						
3	n.c.	6-	≻1				
4	CTRL						
5	GND	<u> </u>	sym141				
6	RF_IN						

Ordering information 3

Table 3. Ordering information					
Type number	Package Name	Description	Version		
BGU7045	-	plastic surface-mounted package; 6 leads	SOT363		

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Marking 4

Table 4. Marking code						
Type number	Marking code	Description				
BGU7045	LK*	* = p: made in Hong Kong				
		* = W: made in China				
		* = t: made in Malaysia				

Limiting values 5

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
V _{CC}	supply voltage	RF input AC coupled		-0.6	3.5	V
V _{CTRL}	voltage on CTRL pin		[1]	0	V _{CC}	V
I _{CC(tot)}	total supply current			-	60	mA
P _{tot}	total power dissipation	T _{sp} ≤ 100 °C	[2]	-	250	mW
Pi	input power	single tone		-	20	dBm
T _{stg}	storage temperature			-65	+150	°C
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-40	+85	°C
V _{ESD}	electrostatic discharge voltage	Human Body Model (HBM); according to JEDEC standard 22- A114E		2	-	kV
		Charged Device Model (CDM); according to JEDEC standard 22- C101B		1.5	-	kV

 V_{CTRL} must not exceed $V_{CC};$ I_{CTRL} must be limited to 5 mA (maximum). T_{sp} is the temperature at the solder point of the ground lead. [1]

[2]

Remark: V_{CTRL} must not exceed V_{CC}; I_{CTRL} must be limited to a maximum of 5 mA.

Thermal characteristics 6

Table 6. Thermal characteristics						
Symbol	Parameter	Conditions		Тур	Unit	
R _{th(j-sp)}	thermal resistance from junction to solder point		[1]	130	K/W	

[1] Determined by final element method simulation with device mounted on application board and in still air.

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Characteristics 7

Table 7. Characteristics

 T_{amb} = 25 °C; typical values at V_{CC} = 3.3 V; Z_S = Z_L = 75 Ω ; R_{bias} = 18 Ω ; 40 MHz ≤ f_1 ≤ 1000 MHz.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{CC}	supply voltage	RF input AC coupled		3.1	3.3	3.5	V
I _{CC(tot)}	total supply current	G _p = 14 dB mode	[1]	30	34	38	mA
		bypass mode	[1]	-	3	-	mA
s ₂₁ ²	insertion power gain	G _p = 14 dB mode	[1]	-	14	-	dB
		bypass mode	[1]	-	-2	-	dB
SL _{sl}	slope straight line	G _p = 14 dB mode		-	-1	-	dB
FL	flatness of frequency response	G _p = 14 dB mode		-	0.2	-	dB
NF	noise figure	G _p = 14 dB mode	[1]	-	2.8	-	dB
		bypass mode	[1]	-	2.5	-	dB
RL _{in}	input return loss	G _p = 14 dB mode	[1]	-	20	-	dB
		bypass mode	[1]	-	9	-	dB
RL _{out}	output return loss	G _p = 14 dB mode	[1]	-	12	-	dB
		bypass mode	[1]	-	10	-	dB
P _{L(1dB)}	output power at 1 dB gain compression	G _p = 14 dB mode; 1 GHz	[1]	-	13	-	dBm
IP3 ₀	output third-order intercept point	G _p = 14 dB mode	[1][2]	-	29	-	dBm
		bypass mode	[1][2]	-	27	-	dBm

[1] Mode depends on setting of V_{CTRL} ; see Table 8. [2] The fundamental frequency (f₁) is 1000 MHz. The intermodulation product (IM3) is $2 \times f_2 - f_1$, where $f_2 = f_1 \pm 1$ MHz. Input power P_i = -10 dBm.

Table 8. Gain selection (pin CTRL)

-10 °C $\leq T_{amb} \leq$ +70 °C; recommended power-up condition: $V_{CTRL} = logic 0 \text{ or } < 0.7 \text{ V}.$

V _{CTRL} (V)	Mode
≤ 0.7	bypass
≥ 1.5	G _p = 14 dB

Remark: V_{CTRL} must not exceed V_{CC}; I_{CTRL} must be limited to a maximum of 5 mA.

8 Application information

- Application notes are available on the NXP website.
- Section 8.1 describes the application circuit used for characterisation and datasheet.
- Section 8.2 describes the recommended application circuit.

8.1 Application circuit



All control and supply lines must be decoupled properly. The decoupling capacitors must be placed as close to the device as possible.

8.2 Recommended application circuit

Recommended application circuit to compensate capacitive load influence at RF input.



(Values can be changed depending on the PCB routing) Keep the components (L2, R3, C6) next to the BGU7045 RF input pin.

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8.3 Application circuit board layout

Table 9. List of components See Figure 1 and Figure 3

See rigue i and rigue o.						
Component	Description	Value		Remarks	Function	
C1, C2	capacitor	10 nF			DC blocking	
C3, C4	capacitor	10 nF			decoupling	
C5	capacitor	10 µF			decoupling	
L1	chip ferrite bead	1.5 kΩ	[1]	Murata BLM18HE152SN1DF	RF choke	
R1	resistor	18 Ω	[1]	R _{bias}	bias setting	
R2	resistor	1.8 kΩ			current limiting	
X1, X2	connector	75 Ω		F-connector, edge mount PCB reflow type, Bomar 861V509ER6	input/output	

[1] L1 and R1 must have a power rating of 0.1 W or higher.

 Table 10. List of components for recommended application circuit

 See
 Figure 2

Component	Description	Value		Remarks	Function
C1, C2	capacitor	10 nF			DC blocking
C3, C4	capacitor	10 nF			decoupling
C5	capacitor	10 µF			decoupling
C6	capacitor	0.5 pF		Murata GRM1555C1HR50BA01	value depends on layout
L1	chip ferrite bead	1.5 kΩ	[1]	Murata BLM18HE152SN1DF	RF choke
L2	inductor	2.7 nH		Murata LQG11A2N7	value depends on layout
R1	resistor	18 Ω	[1]	R _{bias}	bias setting
R2	resistor	1.8 kΩ			current limiting
R3	resistor	47 Ω			
X1, X2	connector	75 Ω		F-connector, edge mount PCB reflow type, Bomar 861V509ER6	input/output

[1] L1 and R1 must have a power rating of 0.1 W or higher.

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9 Package outline



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10 Abbreviations

Table 11. Abbreviations				
Acronym	Description			
AC	Alternating Current			
DC	Direct Current			
ESD	ElectroStatic Discharge			
LNA	Low-Noise Amplifier			
MMIC	Monolithic Microwave Integrated Circuit			
РСВ	Printed-Circuit Board			
RF	Radio Frequency			
SMD	Surface-Mounted Device			

11 Revision history

Table 12. Revision history								
Document ID	Release date	Data sheet status	Change notice	Supersedes				
BGU7045 v.3	20180411	product data sheet	-	BGU7045 v.2				
Modification	added recomment	added recommended application circuit with components table						
BGU7045 v.2	20140526	product data sheet	-	BGU7045 v.1				
Modifications:	• <u>Table 6 on page 3</u> : The information in this table has been updated.							
BGU7045 v.1	20120203	product data sheet	-	-				

12 Legal information

12.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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